

# APPROVAL SHEET

ITEM: MONOLITHIC MULTILAYER

CERAMIC CAPACITOR

(Thin Layer Large-Capacitance Type)

Approved by customer : (signing or stamping here)								

SAMWHA CAPACITOR CO., LTD.							
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2017. 07. 25.

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Home page: www.samwha.com

	< SPEC SUMMARY >									
SPEC.		CS3225X7S475K101NRK								
Type		Thin Lay	er Large-Capacitance							
Item	Specification Unit Test methods and Conditions(Capacitance									
Capacitance	4.7	μF								
Capacitance Tolerance	± 10	%	Testing Frequency: 1 ±0.1kHz Testing Voltage: 1 ±0.2Vrms							
Dissipation Factor	Max. 12.5	%								
Insulation Resistance	More than 10.6	MΩ	Applied the rated voltage for 2 minutes of charging.							
	3.20 ±0.40	L (mm)	-*Capacitance Tolerance Code page 1/8							
Chip Size	2.50 ±0.25	W (mm)	*Chip size page 2/8							
	2.00 ±0.25	T (mm)	*Characteristics & Test Method page 3/8~5/8							

Enactment:	STANDARD	NO	SW - M - 04B
March 27,1996	MONOLITHIC MULTILAYER	Page	1 / 0
,	CERAMIC CAPACITOR LEADLESS TYPE	rage	1 / 8

#### 1. General Article

Application Range

These specifications refer to the "Monolithic Multilayer Ceramic Capacitors Leadless Type "mainly used to the computer equipment, communication equipment.

\*Caution: Industrial equipment / For the high reliability equipment / LED equipment / Etc.

Please contact sales representatives or product engineers before using the products.

(For details, please refer Page 8)

### 2. General Code

(1) Type Designation

<u>CS</u>	<u>3225</u>	<u>X7S</u>	<u>475</u>	<u>K</u>	<u>101</u>	<u>N</u>	<u>R</u>	<u>K</u>
(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)

- 1) Monolithic Multilayer Ceramic Capacitor Leadless Type
- 2) Size Code:

This is expressed in tens of a millimeter.

The first two digits are the length, The last two digits are width.

3) Temperature Coefficient Code

Classification	Code	Temperature Range	Capacitance Tolerance
Class I	Class I C0G −55 to +125°C		±30 ppm/℃
	X5R	-55 to +85℃	±15%
Class II	X7R	-55 to +125℃	±15%
Class II	X7S	-55 to +125℃	±22%
	Y5V	-30 to +85℃	+22% ~ -82%

#### 4) Capacitance Code(Pico farads):

The nominal Capacitance Value in pF is expressed by three digit numbers.

The first two digits represents significant figures and the last digit denotes the number of zero ex) 104 = 100000 pF

R denotes decimal

8R2 = 8.2 pF

# 5) Capacitance Tolerance Code

Code	Tolerance
В	± 0.1 pF
С	± 0.25 pF
D	± 0.5 pF
F	± 1.0 %
G	± 2.0 %
J	± 5 %
K	± 10 %

Code	Tolerance
М	± 20 %
Р	+ 100, -0%
Z	+ 80, -20%
Н	+ 0.25/-0 pF
1	+ 0/-0.25 pF
U	+ 5/-0 %
V	+ 0/-5 %

#### 6) Voltage Code

_													
code	6R3	100	160	250	500	101	201	251	501	631	102	202	302
Val	DC	DC	DC	DC	DC	DC	DC	DC	DC	DC	DC	DC	DC
Vol.	6.3V	10V	16V	25V	50V	100V	200V	250V	500V	630V	1KV	2KV	3KV

#### 7) Termination Code

ex) N: Ni-Sn (Nickel-Tin Plate)

A: Ag/Ni-Sn (Ag Epoxy/Nickel-Tin Plate)

#### 8) Packing Code

ex) R: 7" Reel Type L: 13" Reel Type B: Bulk Type

#### 9) Thickness option (Cu, Ag Epoxy)

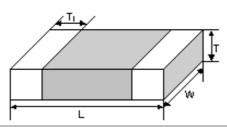
Thickness(mm)		Code	Thickne	Code	
t	Tol(±)	Oode	t	Tol(±)	Oode
0.30	0.03	Blank	1.30	0.20	Е
0.50	0.05	Blank	1.35	0.20	Н
0.60	0.10	А	1.60	0.20	I
0.80	0.10	В	1.80	0.20	J
0.85	0.15	В	2.00	0.25	K
1.00	0.15	E	2.50	0.25	L
1.10	0.15	E	2.80	0.30	М
1.15	0.15	E	3.20	0.30	N
1.25	0.15	E	5.00	0.40	0

### 3. Temperature Characteristics

See Page 5/8 (No.13)

#### 4. Constructions and Dimensions

(I) Dimensions



(Unit: mm)

	Dimension								
Codo		Len	gth	Wi					
Code	1	Cu	Ag E	роху	Cu, Ag	T1(min)			
	L	Tol(±)	Tol(-)	Tol(+)	W	Tol(±)			
0603	0.60	0.03	_	_	0.30	0.03	0.05		
1005	1.00	0.05	0.05	0.10	0.50	0.05	0.05		
1608	1.60	0.15	0.15	0.20	0.80	0.10	0.10		
2012	2.00	0.20	0.20	0.30	1.25	0.15	0.10		
3216	3.20	0.30	0.30	0.40	1.60	0.20	0.15		
3225	3.20	0.40	0.40	0.40	2.50	0.25	0.15		
4520	4.50	0.40	0.40	0.40	2.00	0.25	0.20		
4532	4.50	0.40	0.40	0.40	3.20	0.30	0.20		
5750	5.70	0.50	0.50	0.50	5.00	0.40	0.30		

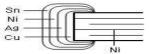
\*1005 Size  $\geq 4.7 \mu F \Rightarrow L, W, T : Tol \pm 0.15$ 

\*1608 Size  $\geq 10 \mu F \Rightarrow W : 0.80 \pm 0.15, T : 0.80 \pm 0.15$ 

\*2012 Size ≥10 $\mu$ F  $\Rightarrow$  W : 1.25±0.20, T : 0.85±0.15 \*3216 Size ≥47 $\mu$ F  $\Rightarrow$  W : 1.60±0.30, T : 1.60±0.30

# (2) Construction of Termination







(Inner Electrode : Ni Type I) (Inner Electrode : Ni Type II) (Inner Electrode : Ag/pd Type)

# Specifications and Test Methods (Thin Layer Large-Capacitance Type)

No.	Ite	em	Specification	Test Methods and Conditions				
1	Operating Temperature Range		X7R, X7S : -55 to +125°C X5R : -55 to +85°C Y5V : -30 to +85°C					
2	Insulation Resistance		50Ω·F min	Applied the rated voltage for 2 minu The charge/discharge current is less th				
3	Dielectric Str	rength	No defects or abnormalities	X7R, X7S, X5R, Y5V: The rated voltage × 250%  - Applied between the terminations for 1 to 5 seconds.  - The charge/discharge current is less than 50mA.				
4	Capacitance		within the specified tolerance	ne capacitance/D.F. should be measured agreement and veltage shown in the tab				
5	Dissipation Factor		X7R, X7S, X5R: 12.5%max *3216 Size 100 <sub>\(\mu\)</sub> F: 15%max Y5V: 20%max	Capacitance Frequency  C≤10μF 1 ± 0.1kHz  C>10μF 120 ± 24Hz  Initial measurement Perform the initial measurement according to Note1 for Class II	Voltage  0.5~1.0Vrms  0.5±0.1Vrms			
6	Solderability Termination	of	-Termination should be covered with more than 75% of new solder	Measurement after test Fake it out and set it for 24±2 hours hen measure Pb-Free type Solder: 96.5Sn-3Ag-0.5Cu Solder temperature: 245±5°C Immersion time: 3±0.1sec	(Class II)			
		Appearance	No marking defects	Pre-Heating: at 80~120°C for 10~ reheat the capacitor at 120 to 150°C Preheating for 3225,4520,4532				
	Resistance	Capacitance change	X7R, X7S, X5R: Within±7.5% Y5V: Within±20%	Step1:100° to 120°, 1min Step2:170° to 200°, 1min ) nmerse the capacitor in a eutectic s 60±5° for 10±0.5 seconds.	solder solution at			
7	to Soldering Heat	Dissipation Factor	X7R, X7S, X5R : 12.5%max *3216 Size 100μF : 15%max Y5V : 20%max	nitial measurement Perform the initial measurement acc	cording to Note1 for			
		I.R.	50Ω·F min	ass II surement after test sit at room temperature for 24±2 hours,then mea				
		Appearance	No marking defects	Perform the five cycles according to the sted in the following table.				
		Capacitance Change	X7R, X7S, X5R : Within ±7.5% Y5V : Within ±20%		3 4 Max. erating Room			
8	Temperature cycle	nperature Dissipation Factor X7R, X7S, X5R : 12.5%max *3216 Size 100 <sub>\(\rho\)</sub> F : 15%max Y5V : 20%max		+0/-3 + Time 30+3 2 to3 3	emp. Temp -3/-0 0±3 2 to3			
		I.R	50Ω·F min	·Initial measurement Perform the initial measurement according to Note1 for Class II ·Measurement after test Perform the final measurement according to Note2				

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No.	Item		Specification	Test Methods and Conditions				
		Appearance	No marking defects					
9	High Temperature Load	Capacitance Change	X7R, X7S, X5R: Within ±12.5% Y5V: Within ±30%	Apply 150% of the rated voltage for 1000+48/-0 hrs at the maximum operating temperature ±3°C. The charge/discharge current is less than 50mA.				
		Dissipation Factor	X7R, X7S, X5R: 20%max *3216 Size 100 <sub>4</sub> F: 30%max Y5V: 40%max	-Initial measurement Perform the initial measurement according to Note1 for Class II				
		I.R	12.5Ω·F min	-Measurement after test Perform the final measurement according to Note2				
10	Bending strength		20mm F R230	·Substrate material : Glass EPOXY Board. ·Thickness : 1.6mm     0.8mm(0603/1005size)  *. Test condition - Bending limit: 1mm				
		Capacitance Change	No cracking or marking defects shall occur  X7R, X7S, X5R: Within ±12.5% Y5V : Within ±30% Within +30/-40% (cap≥10 μF)	<ul><li>Pressurizing speed : 1mm/sec</li><li>Holding time : 5±1sec</li></ul>				
		Appearance	No defects or abnormalities					
		Capacitance	Whin the specified tolerance	*Shown in Fig. After soldering and then let sit for 24±2hr at room temperature. The capacitor should be subjected to a simple				
11	Vibration Resistance	Dissipation Factor	X7R, X7S, X5R : 12.5%max *3216 Size 100⊭ : 15%max Y5V : 20%max	harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz, shall be traversed(from 10Hz to 55Hz then 10Hz again) in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3mutually perpendicular directions(total is 6hours).				
	Humidity Load	Appearance	No marking defects	Apply the rated voltage at 40±2℃ and				
12		Capacitance Change	X7R, X7S, X5R: Within ±12.5% Y5V : Within ±30%	90 to 95%RH for 500+24/-0 hrs. The charge/discharge current is less than 50mA.				
		Dissipation Factor	X7R, X7S, X5R: 20%max *3216 Size 100 <sub>4</sub> F: 30%max Y5V: 40%max	Perform the initial measurement according to Note1 for Class II  Measurement after test				
		I.R.	12.5Ω·F min	Perform the final measurement according to Note2				

N	lo.	Item	Specification					Test Methods and Conditions			
1	13	Capacitance Temperature Characteristics	Char.  X5R  X7R  X7S  Y5V	Temp. Range  -55 to +85℃  -55 to +125℃  -55 to +125℃  -30 to +85℃	Reference Temp. 25°C 25°C 25°C 25°C	Within Within Within	Change  ±15%  ±15%  ±22%  -22/-82%	The capacitance change should be measured after 5 min. at each specified temperature stage.  The ranges of capacitance change compared with the 25°C value over the temperature ranges shown in the table should be within the specified ranges.			

#### \*Note1. Initial Measurement for Class II

Perform a heat treatment at 150+0,-10℃ for one hour and then let sit for 24±2 hours at room temperature, then measure

#### \*Note2. Measurement after test

Clace I

Perform a heat treatment at 150+0,-10°C for one hour and then let sit for 24±2 hours at room temperature, then measure.

# 5. Packing

- (1) Bulk packing
  - 1 1000 pcs per Polybag
  - 2 5 Polybags per Inner box
  - 3 10 Inner boxes per Out box
- (2) Reel Packing
  - ① 8~10 Reels per Inner box
  - 2 6 Inner boxes per Out box
- (3) Reel Dimensions



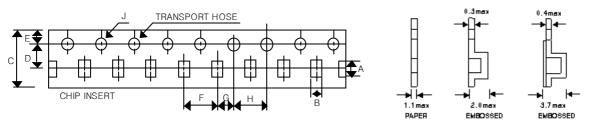


						(L	Jnit: mm)
MARK	SIZE	Α	В	С	D	E	W
7 " RFFI	0603~3225	Φ178±2	Ф50Min	Ф13±0.5	Φ21±0.8	2±0.5	10±1.5
/ REEL	4520~4532	Ф180+0,-3	Ф60-0,+1	Φ13±0.2	Ф57-0+1	3±0.2	13±0.5
13 " REEL	1005~3225	Ф330±2	Ф70Min	Φ13±0.5	Φ21±0.8	2±0.5	10±1.5

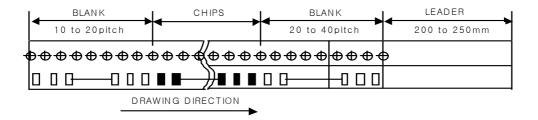
#### (4) Number of Package

TYPF	EIA CODE	7"	13"		
ITE	EIA CODE	Qt/REEL	Qt/REEL		
CS0603	CC0201	15,000			
CS1005	CC0402	10,000	50,000		
CS1608	CC0603	4,000	16,000		
CS2012	CC0805	3,000 ~ 4,000	10,000		
CS3216	CC1206	2,000 ~ 4,000	6,000 ~ 10,000		
CS3225	CC1210	1,000 ~ 3,000	4,000 ~ 10,000		
CS4520	CC1808	1,500 ~ 3,000	_		
CS4532	CC1812	500 ~ 1,000	1,500 ~ 5,000		

#### (5) Tape Dimensions



TYPE	EIA CODE	А	В	С	D	Е	F	G	Н	J
CS0603	CC0201	0.67±0.05	0.37±0.05	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	2.0±0.1	4.0±0.1	1.5±0.1
CS1005	CC0402	1.15±0.1	0.65±0.1	8.0±0.3	3.5±0.05	1.75±0.1	2.0±0.05	2.0±0.1	4.0±0.1	1.5±0.1
CS1608	CC0603	1.9±0.2	1.10±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1
CS2012	CC0805	2.4±0.2	1.65±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1
CS3216	CC1206	3.6±0.2	2.00±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1
CS3225	CC1210	3.5±0.2	2.80±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1
CS4520	CC1808	4.8±0.2	2.3±0.2	12.0±0.3	5.5±0.1	1.75±0.1	4.0±0.1 8.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1
CS4532	CC1812	4.9±0.2	3.6±0.2	12.0±0.3	5.5±0.1	1.75±0.1	8.0±0.1	2.0±0.1	4.0±0.1	1.5±0.1



#### 6.Caution

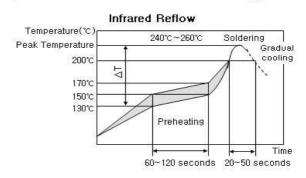
#### ▶ Reflow Soldering

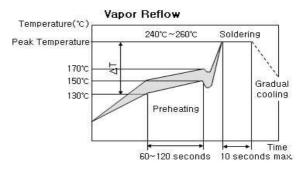
- 1. The sudden temperature change easily causes mechanical damages to ceramic components. Therefore, the preheating procedures should be required for the soldering of ceramic components.
- 2. Please refer to the recommended soldering profiles as shown in figures, and keep the temperature difference  $(\triangle T)$ within the range recommended in Table 1.

#### Table 1

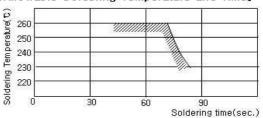
Size code	Temperature Difference
0603, 1005, 1608, 2012, 3216	△T≤190°C
3225size and over	△T≤130°C

#### [Standard Conditions for Reflow Soldering]





#### [Allowable Soldering Temperature and Time]



In case of repeated soldering, the accumulated soldering time must be within the range shown above.

#### ► Storage Condition

\*When Solderability is considered, Capacitor are recommended to be used in 12 months

(1) Temperature:  $25^{\circ}$ C  $\pm$   $10^{\circ}$ C

(2) Relative Humidity: Below 70% RH

- ▶ The Regulation of Environmental Pollution Materials.
  - \*Never use materials mentioned below in MLCC products regulated this document.

Pb, Cd, Hg, Cr<sup>+6</sup>, PBB(Polybromide biphenyl), PBDE(Polybrominated diphenyl ethers), asbestos.

#### Note

#### (1) 'Aging'/'De-aging' Behavior of high dielectric MLCCs

(Typically represented by X7R, Y5V temperature characteristic of which main composition is BaTiO3)

'Aging' / 'De-aging' Behavior of high dielectric MLCCs Please note that high dielectric type dielectric Ceramic Capacitors have a "normal" 'aging' behavior / characteristic, that is; their capacitance value decreases with time from its value when it was first manufactured. From that date, the capacitance value begins to decrease at a logarithmic rate defined by:

$$C_t = C_{24} (1 - k \log 10 t)$$

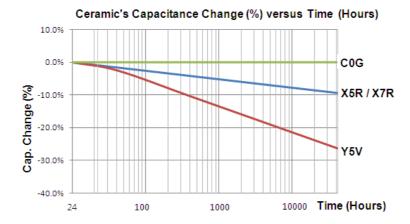
where:

Ct = Capacitance Value, t hours after the start of 'aging'

C<sub>24</sub> = Capacitance Value, 24 hours after its manufacture

k = aging constant ( capacitance decrease per decade-hour )

t = time, in hours, from the start of 'aging'



The capacitance value can be restored (a.k.a. 'de-aged') by exposing the component to elevated temperatures approaching its Curie Temperature (approximately 120°C). This 'deaging' can occur during the component's solder-assembly onto the PCB, during life or temperature cycle testing., or by 'baking 'at 150°C for about 1 hour.

Dielectric	Maximum Percent Capacitance Loss per Decade hour, k
COG	0
X5R/X7R	~3%
Y5V	~8%

- (2) Please contact our sales representatives or product engineers before using the products in this catalog for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this catalog.
  - ①Aircraft equipment
- ②Aerospace equipment
- ③Undersea equipment

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- ©Transportation equipment (vehicles, trains, ships, etc.)
- Traffic signal equipment Spisaster prevention / crime prevention equipment
- Industrial equipment (Conveyors, Robot equipment, etc)

- @Led equipment

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>>SAMWHA(三和)